

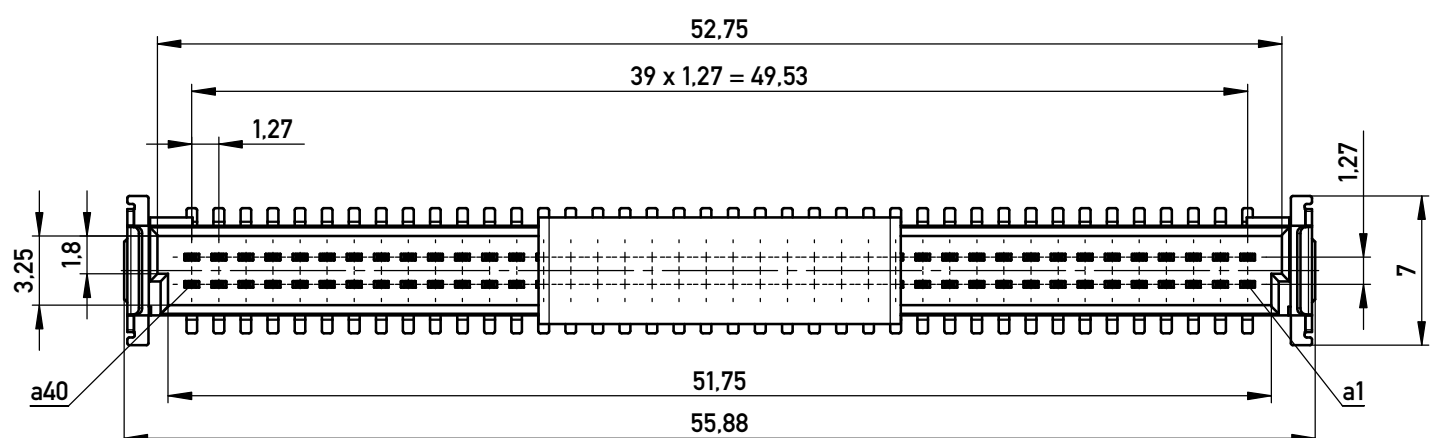
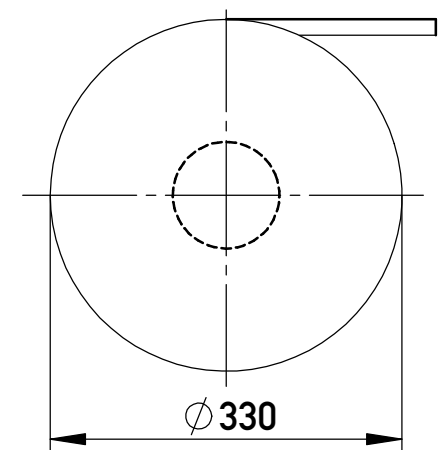
Anforderungsstufe 1  
Performance Level 1

Kontaktbereich vergoldet  
Mating Area gold plating

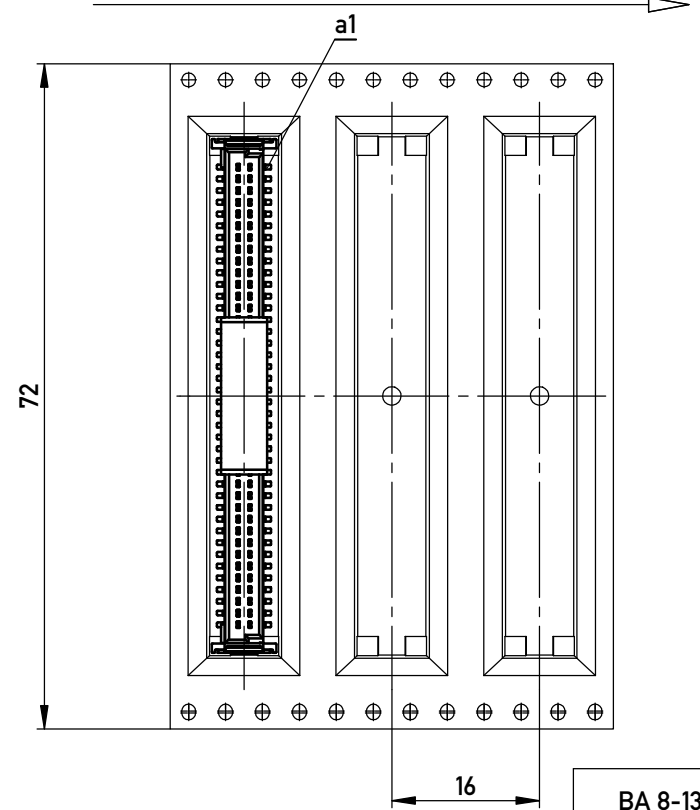
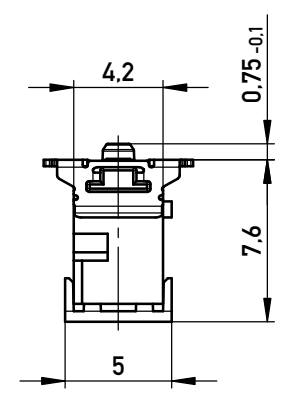
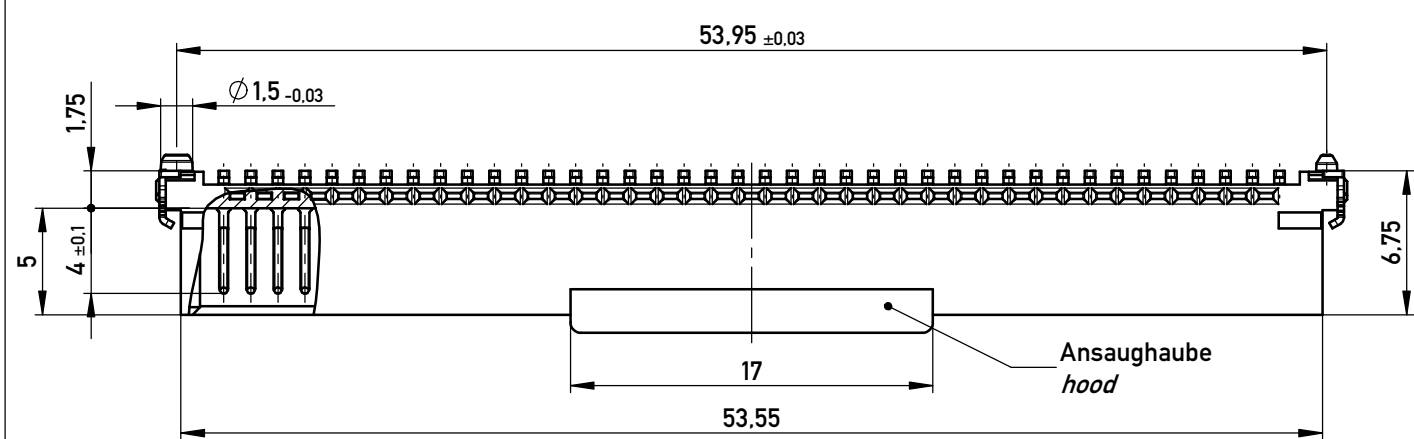
Anschlussbereich verzinkt 4-6 µm  
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm  
Coplanarity Area of Termination ≤ 0,1 mm

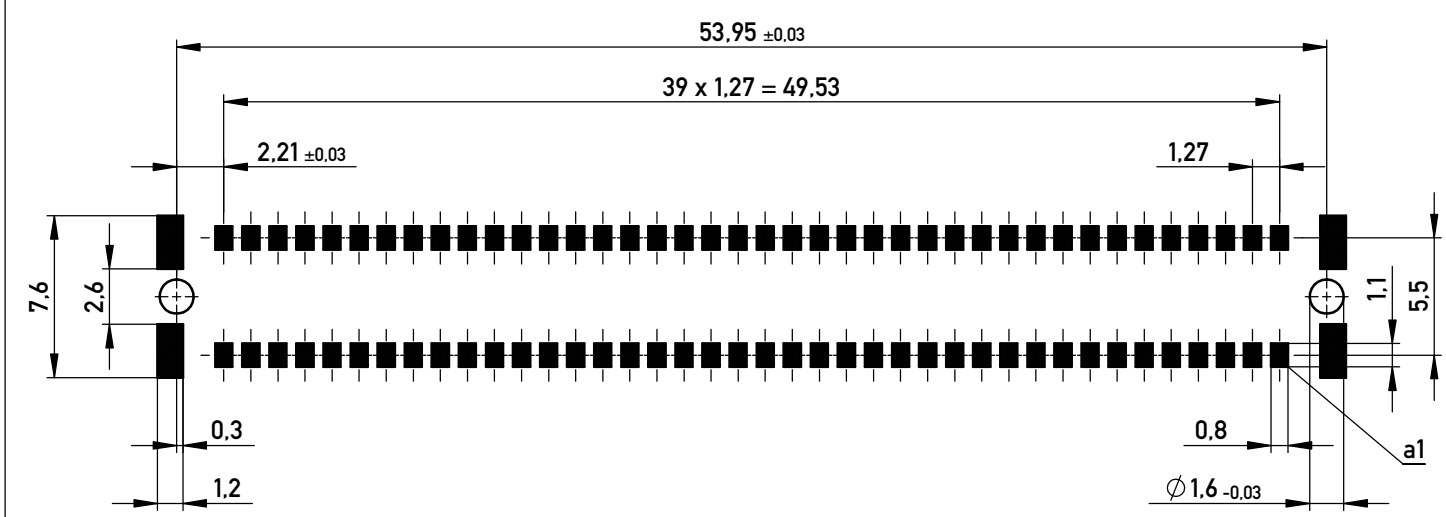
Verpackt in Gurtverpackung  
Tape on Reel Packaging  
Verpackungseinheit: 280 Stück  
Packaging unit: 280 pcs



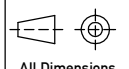

Abspulrichtung - Reel off Direction



Leiterplatten-Layout Vorschlag für SMT  
PCB-Layout Proposal for SMT



BA 8-13 - 8mm Bauhöhe  
type 8-13 - Low Profile

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	Subject to modification without prior notice. Drawing will not be updated.	 www.ERNI.com	<b>100503140001</b>	K A3
d Index	23.07.2013 Date	Class SMCQ		

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